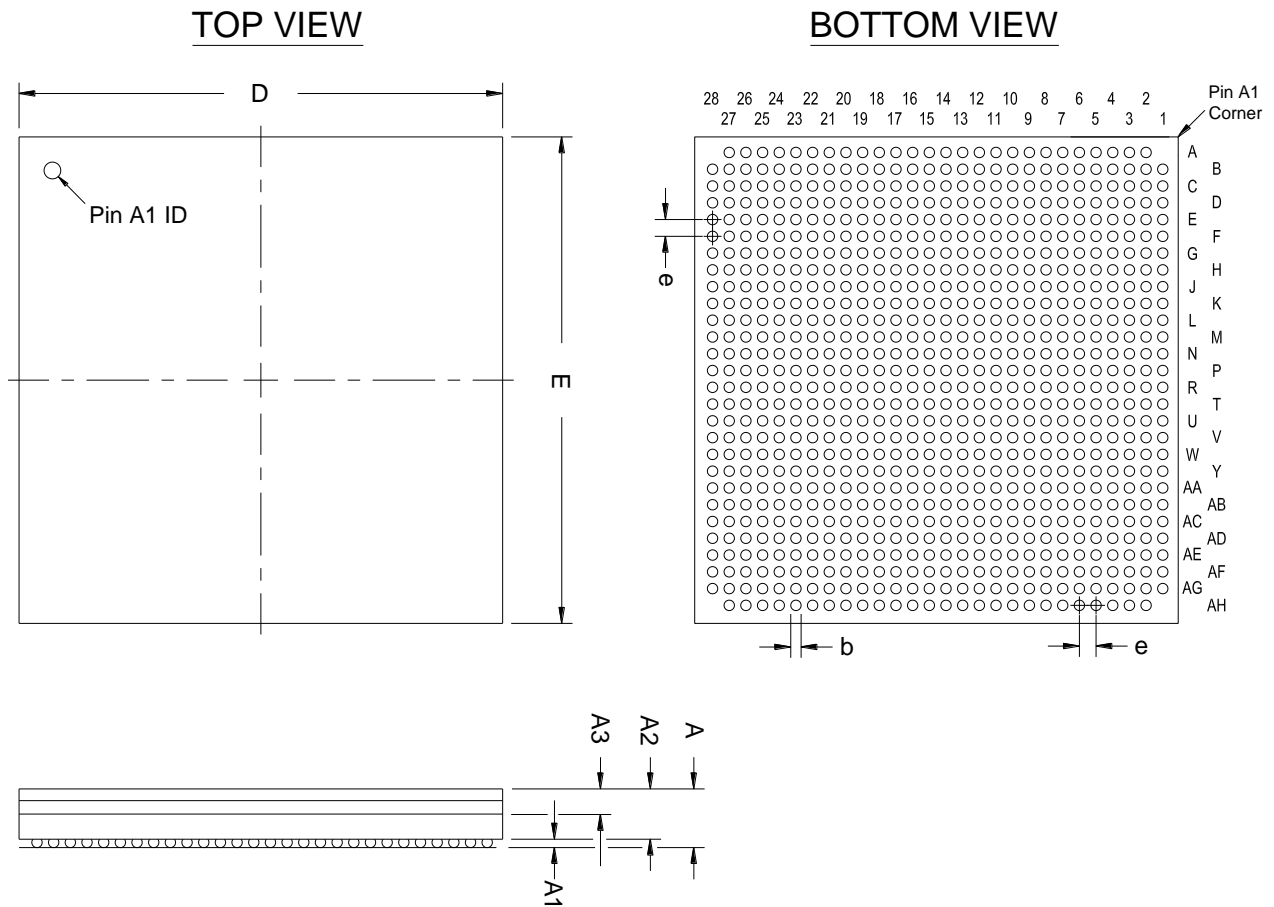


780-Pin FineLine Ball-Grid Array (FBGA) - Flip Chip - Dual-Piece Lid - A:3.20

- All dimensions and tolerances conform to ASME Y14.5M – 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information	
Description	Specification
Ordering Code Reference	F
Package Acronym	FBGA
Substrate Material	BT
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)
JEDEC Outline Reference	MS-034 Variation: AAM-1
Lead Coplanarity	0.008 inch (0.20 mm)
Weight	10.0 g (Typ.)
Moisture Sensitivity Level	Printed on moisture barrier bag

Package Outline Dimension Table			
Symbol	Millimeters		
	Min.	Nom.	Max.
A	2.90	3.05	3.20
A1	0.40	0.50	0.60
A2	2.30	2.55	2.80
A3	1.40	1.50	1.60
D	29.00 BSC		
E	29.00 BSC		
b	0.50	0.60	0.70
e	1.00 BSC		

Package Outline

Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
June 2011	1.0	Initial release



101 Innovation Drive
San Jose, CA 95134
www.altera.com

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